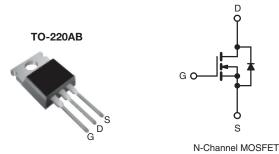


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.028				
Q _g (Max.) (nC)	67				
Q _{gs} (nC)	18				
Q _{gd} (nC)	25				
Configuration	Single				



FEATURES

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFZ40PbF			
Lead (FD)-life	SiHFZ40-E3			
SnPb	IRFZ40			
	SiHFZ40			

ABSOLUTE MAXIMUM RATINGS (T _c = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	60	V	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current ^e	V _{GS} at 10 V	T _C = 25 °C	- I _D -	50		
Continuous Drain Current	VGS at 10 V	$T_C = 100 \ ^\circ C$		36	А	
Pulsed Drain Current ^a			I _{DM}	200		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Maximum Power Dissipation	num Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			150	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175		
Soldering Recommendations (Peak Temperature) ^d	for 10 s			300	- °C	
	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 44 µH, R_g = 25 Ω , I_{AS} = 51 A (see fig. 12).

c. $I_{SD} \le 51$ A, dl/dt ≤ 250 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

e. Current limited by the package, (die current = 51 A).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	тур	1	MAY		i	LINUT	
		TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 62			°C/W			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 - - 1.0						
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	vise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI	
Static								•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, l	_D = 1 mA	-	0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	50 µA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 \	/	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	-	= 60 V, V _{GS}		-	-	25	μA
			, V _{GS} = 0 V,		-	-	250	μ/ (
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$		= 31 A ^b	-	-	0.028	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 25 V, I _D =	31 A	15	-	-	S
Dynamic		T					1	
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$ $V_{DS} = 25 V,$		-	1900	-	pF
Output Capacitance	C _{oss}				-	920	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	170	-		
Total Gate Charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 51 \text{ A}, V_{DS} = 4 \text{ see fig. 6 and 1}$			-	-	67	nC
Gate-Source Charge	Q _{gs}			A, V _{DS} = 48 V, ig. 6 and 13 ^b	-	-	18	
Gate-Drain Charge	Q _{gd}				-	-	25	
Turn-On Delay Time	t _{d(on)}		•		-	14	-	
Rise Time	t _r	V _{DD} = 30 V, I _D = 51 A,		-	110	-	1	
Turn-Off Delay Time	t _{d(off)}			, see fig. 10 ^b	-	45	-	- ns
Fall Time	t _f				-	92	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") f	Between lead,		-	4.5	-	
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	- nH	
Drain-Source Body Diode Characteristic	s					•	•	•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	200		
Body Diode Voltage	V_{SD}	T _J = 25 °C	$T_J = 25 \text{ °C}, I_S = 51 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/μs		-	120	180	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.53	0.80	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is dor	ninated b	v L - and	L

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

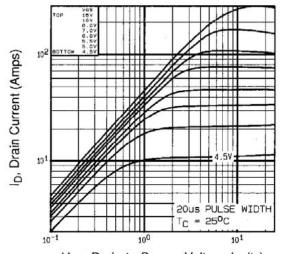
b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



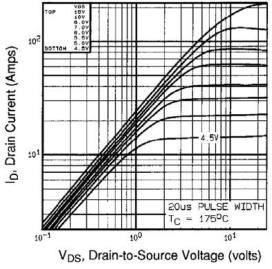


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

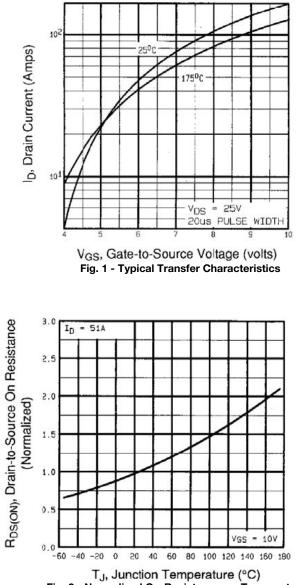


Fig. 2 - Normalized On-Resistance vs. Temperature

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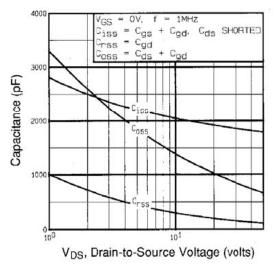


Fig. 3 - Typical Capacitance vs. Drain-to-Source Voltage

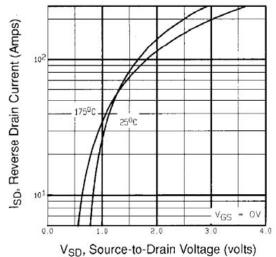


Fig. 5 - Typical Source-Drain Diode Forward Voltage

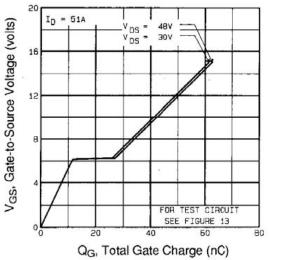
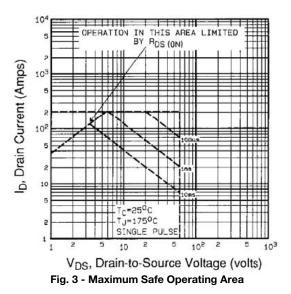


Fig. 4 - Typical Gate Charge vs. Gate-to-Source Voltage



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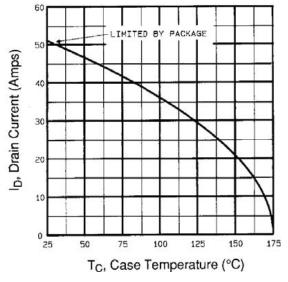


Fig. 9 - Maximum Drain Current vs. Case Temperature

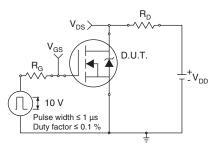


Fig. 10a - Switching Time Test Circuit

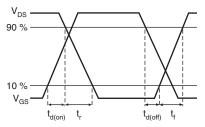
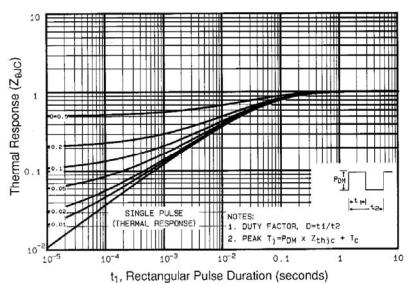


Fig. 10b - Switching Time Waveforms





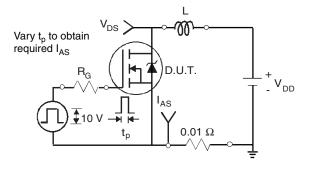
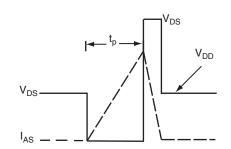
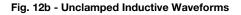


Fig. 12a - Unclamped Inductive Test Circuit





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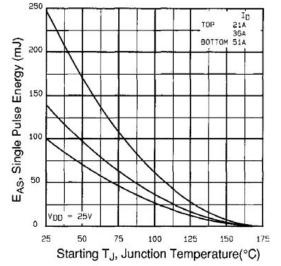


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

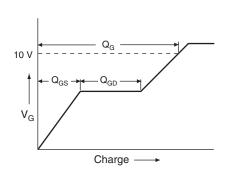


Fig. 13a - Basic Gate Charge Waveform

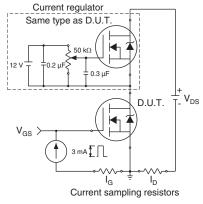
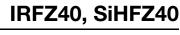


Fig. 13b - Gate Charge Test

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Peak Diode Recovery dV/dt Test Circuit

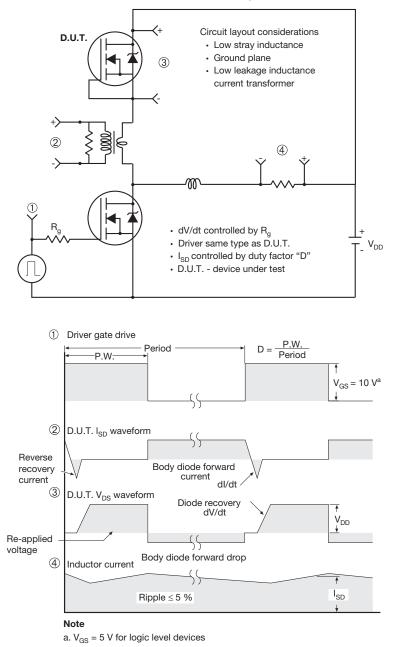


Fig. 14 - For N-Channel

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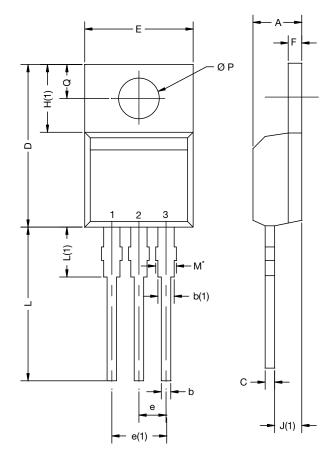
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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

Document Number: 66542

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